



v01.0700

## HMC199MS8 MSOP8 DUAL SPDT SWITCH DC - 2.5 GHz

FEBRUARY 2001

Features

INTEGRATED DUAL SPDTs

LOW INSERTION LOSS: <0.5 dB @ 2.0 GHz

POSITIVE CONTROL: 0/+5V

ULTRA SMALL MSOP8 PACKAGE: 14.8 mm<sup>2</sup>

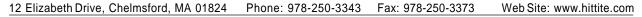


## **General Description**

The HMC199MS8 is a low-cost dual SPDT GaAs "bypass" switch in an 8-lead MSOP package covering DC to 2.5 GHz. This four RF port component integrates two SPDT switches and a through line onto a single IC. The design provides low insertion loss of less than 0.5 dB while switching passive or active external circuit components in and out of the signal path. Port to port isolations are typically 35 to 20 dB. On-chip circuitry enables positive voltage control operation at very low DC currents with control inputs compatible with CMOS and most TTL logic families. Applications include LNA or filter bypass switching and single bit attenuator switching for cellular, PCS, and ISM base stations.

## Guaranteed Performance Vctl = 0/ +5 Vdc, 50 Ohm System, -40 to +85 deg. C

| Parameter                               | Frequency     | Min. | Тур. | Max. | Units |
|---|---------------|------|------|------|-------|
|   | DC - 1.0 GHz  |      | 0.3  | 0.6  | dB    |
| Insertion Loss                          | DC - 2.0 GHz  |      | 0.5  | 0.8  | dB    |
|   | DC - 2.5 GHz  |      | 0.7  | 1.0  | dB    |
| Isolation                               | DC - 2.0 GHz  | 22   | 25   |      | dB    |
|   | DC - 2.5 GHz  | 17   | 21   |      | dB    |
| Return Loss (On State, Any Port)        | DC - 2.0 GHz  | 22   | 25   |      | dB    |
|   | DC - 2.5 GHz  | 14   | 17   |      | dB    |
| Input Power for 1dB Compression         | 0.5 - 2.0 GHz | 19   | 23   |      | dBm   |
| Input Third Order Intercept             | 0.5 - 2.0 GHz | 32   | 36   |      | dBm   |
| (Two Tone Input Power= 0 dBm Each Tone) |               |      |      |      |       |
| Switching Characteristics               | DC - 2.5 GHz  |      |      |      |       |
| tRISE / tFALL (10/90% RF / 90/10% RF)   |               |      | 20   |      | nS    |
| tON / tOFF (50% CTL to 10/90% RF)       |               |      | 40   |      | nS    |

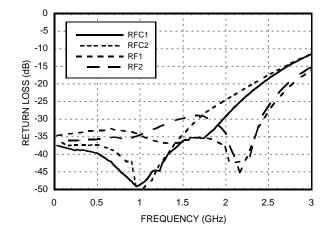


SWITCHES

SPDT

SMT

## Return Loss



Note: Isolation between RF1 - RF2 (when RFC1 -RFC2 is in insertion loss state) is 25 dB @ 1 GHz and 17 dB @ 2 GHz.

## Compression vs Frequency

|             | Carrier  | Carrier at 900MHz                     |   | 1900MHz                               |
|-------------|----------|---------------------------------------|---|---------------------------------------|
| CTL<br>Inpu | for 01dB | Input Power<br>for 1dB<br>Compression | Input Power<br>for 0.1dB<br>Compression | Input Power<br>for 1dB<br>Compression |
| (Vda        | :) (dBm) | (dBm)                                 | (dBm)                                   | (dBm)                                 |
| +5          | 20       | 23.5                                  | 19                                      | 22                                    |

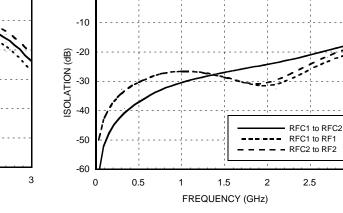
Caution: Do not operate continuously at RF power input greater than 1dB compression and do not "hot switch" power levels greater than +13 dBm (Control =0/+5Vdc).

## **Distortion vs Frequency**

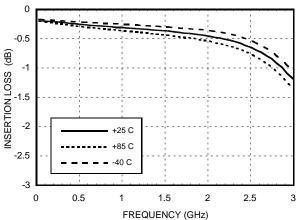
| Control Input | Input Third Order Intercept (dBm)<br>0 dBm Each Tone |          |  |
|---------------|--|----------|--|
| (Vdc)         | 900 MHz  | 1900 MHz |  |
| +5            | 34.5   | 37.5     |  |

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## Insertion Loss



## Isolation

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# HMC199MS8



**S**WITCHES



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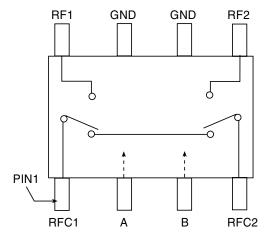


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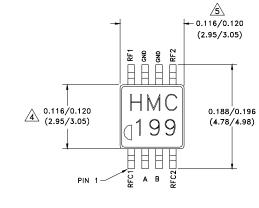
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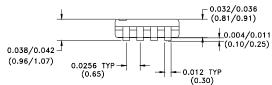
## Functional Diagram

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## **Outline Drawing**





### MATERIAL: A) PACKAGE BODY - LOW STRESS INJECTION-MOLDED PLASTIC. 🔔 DIMENSION DOES NOT INCLUDE MOLDFLASH OF 0.15 MM PER SIDE

DIMENSION DOES NOT INCLUDE MOLDFLASH OF 0.25 MM PER SIDE

- 1. B) LEADFRAME MATERIAL: COPPER ALLOY
- 2. PLATING: LEAD TIN SOLDER PLATE
- DIMENSIONS ARE IN INCHES (MILLIMETERS). З.
- UNLESS OTHERWISE SPECIFIED ALL TOL. ARE ±0.005(±0.13).

## Absolute Maximum Ratings

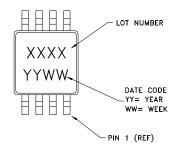
| RF Input Power Vctl = 0/+5V   | +24 dBm           |
|-------------------------------|-------------------|
| Control Voltage Range (A & B) | -0.5 to +7.5 Vdc  |
| Storage Temperature           | -65 to +150 deg C |
| Operating Temperature         | -40 to +85 dec C  |

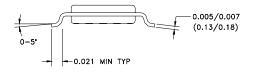
## Truth Table

| * | Control | Input | Tolerances | are | +/- | 0.5 | Vdc |  |
|---|---------|-------|------------|-----|-----|-----|-----|--|
|   |         |       |            |     |     |     |     |  |

| Contro     | ollnput*   | Control Current<br>(Typical) |            | 5                  | n                 |                   |
|------------|------------|------------------------------|------------|--------------------|-------------------|-------------------|
| A<br>(Vdc) | B<br>(Vdc) | la<br>(uA)                   | lb<br>(uA) | RFC1<br>to<br>RFC2 | RFC1<br>to<br>RF1 | RFC2<br>to<br>RF2 |
| 0          | +5         | -65                          | 65         | On                 | Off               | Off               |
| +5         | 0          | 65                           | -65        | Off                | On                | On                |

DC blocking capacitors are required at ports RFC1, RFC2, RF1, RF2. Choose value for lowest frequency of operation.





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12 Elizabeth Drive, Chelmsford, MA 01824 Phone: 978-250-3343 Fax: 978-250-3373 Web Site: www.hittite.com



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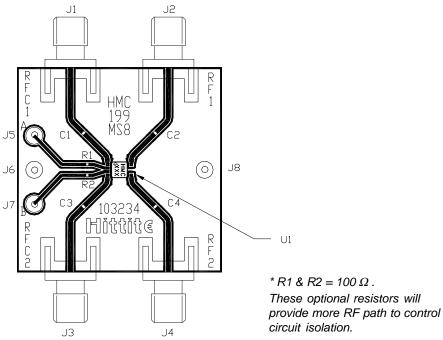
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## Eval Board Layout (Top View)

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The circuit board used in the final application should be generated with proper RF circuit design techniques. Signal lines at the RF port should have 50 ohm impedance. The evaluation circuit board shown above is available from Hittite Microwave Corporation upon request.

| Item                                   | Description  |  |
|--|--|--|
| J1 - J4                                | PC Mount SMA Connector   |  |
| J5 - J8                                | DC Pin   |  |
| C1 - C4                                | Chip Capacitor, 0402 Pkg. Choose value for lowest frequency of operation. 330 pF is provided on PCB. |  |
| R1 - R2                                | 100 ohm Resister, 0402 Pkg.  |  |
| U1                                     | HMC199MS8 Bypass Switch  |  |
| PCB*                                   | 103234 Evaluation PCB 1.5" x 1.5"  |  |
| * Circuit Board Material : Rogers 4350 |  |  |



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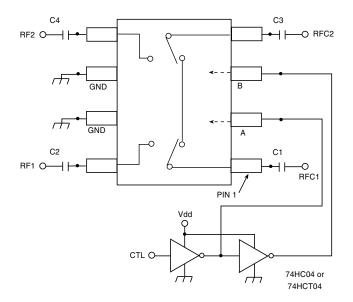


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## **Typical Application Circuit**



#### Notes:

- 1. Set A / B control to 0/+5V, Vdd = +5V and use HCT series logic to provide a TTL driver interface.
- 2. Control inputs A/B can be driven directly with CMOS logic (HC) with Vdd = 5 to 7 Volts applied to the CMOS logic gates.
- 3. DC Blocking capacitors are required for each RF port as shown. Capacitor value determines lowest frequency of operation.
- 4. Highest RF signal power capability is achieved with Vdd = +7V and A/B set to 0/+7V.

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NOTES: